

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
WEI-TA FU	07/01/2015
YU-CHIH LIN	07/01/2015
RECEIVING PARTY DATA	
Name:	NAN YA PCB CORPORATION
Street Address:	NO.338, SEC. 1 NANKAN RD., LUCHU DIST.
City:	TAOYUAN CITY
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14790669
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SIGNATURE:	/Nelson A. Quintero/
DATE SIGNED:	07/07/2015
Total Attachments: 1	
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ASSIGNMENT

WHEREAS, Wei-Ta FU, Kuo-Chang WU and Yu-Chih LIN
hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as
described and set forth in the below identified application for United States Letters Patent:

Title: EMBEDDED COMPONENT SUBSTRATE AND METHOD FOR FABRICATING
THE SAME

Filed: _____ Serial No.: _____
Executed on: July 1, 2015

WHEREAS, NAN YA PCB Corporation of No.338, Sec. 1 Nankan Rd., Luchu Dist., Taoyuan City, Taiwan (R.O.C) hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Wei-Ta Fu

2015/7/1

Date

Kuo-Chang KU

Date _____

Yu-Chih LIN

2015/7/1
Date